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February 13, 2002

Assistant Commissioner for Patents Box Patent Application Washington, D.C. 20231

Re:

HETEROJUNCTION BIPOLAR TRANSISTOR WITH InGaAs CONTACT

AND ETCH STOP LAYER FOR InP SUB-COLLECTOR

Docket No. 01SC027US1

Sir:

Transmitted herewith for filing under 35 U.S.C. 111 and 37 CFR 1.53 is the patent application of Richard L. Pierson, Jr., James Chingwei Li, Berinder P.S. Brar and John A. Higgins entitled HETEROJUNCTION BIPOLAR TRANSISTOR WITH InGaAs CONTACT AND ETCH STOP LAYER FOR InP SUB-COLLECTOR.

Enclosed are:

EEE MARD S. KOPPEL MARYIN E. JACOBS, P.C.

EVÉN C. PATRICK

EOUIS A. MOK

STEVEN C. SEREBOFF

E G. HEYBL

or Counsel

Of Counsel

Patent Agent
JOSEPH COMPTON

17 pages of written description, claims and abstract.

6 sheets of drawings plus 2 copies.

An Assignment of the invention to Rockwell Technologies, LLC.

Executed Declaration and Power of Attorney.

The filing and recording fees have been calculated as shown below:

 Basic Fee
 \$740.00

 Total Claims
 $(32-20) \times $18.00 =$ 216.00

 Independent Claims
 $(5-3) \times $84.00 =$ 168.00

 Assignment Recording Fee
 40.00

 Total Fee:
 \$1,164.00

Please charge Deposit Account No. 18-1750 in the amount of \$1,164.00 to cover the filing and recording fees. We authorize the Commissioner to charge (1) payment of any additional filing fees required under 37 CFR §1.16, (2) payment of any patent application processing fees under 37 CFR §1.17 associated with this communication, or (3) payment of any fees that occur during the pendency of this application (and to credit any overpayment) to Deposit Account No. 18-1750. We enclose a duplicate copy of this sheet.

Very truly yours,

KOPPEL, JACOBS, PATRICK & HEYBL

Richard S. Koppel

Registration No. 26,475

Enclosures

M/D3-01SC027US1RSC Transmittal ltr.doc

